PCN Number:	20130410000 PCN Date: 04/11/2013											
Title: OPA4188 Data Sheet												
Customer Contact: PCN Manager Phone: +1(214)480-6037 Dept: Quality Services												
Proposed 1 st Ship Date:		07/11/2013		Estimated Sample Availability:				Date provided upon request				
Change Type:					-							
Assembly Site								Assembly Materials				
Design								Mechanical Specification				
Test Site		Packing/Shipping/Labeling						est Proce				
Wafer Bump Site			r Bump I					Wafer Bump Process				
Wafer Fab Site		Wafe	r Fab Ma				V	/afer Fab) Prc	ocess		
	PCN Details											
Description of Change:												
The following change h datasheet links provide		provide	s further	r details.	These cha	ang	ges	may be r	revie	ewed at the OPA4188		
www.ti.com SBOS641B – JUNE 2012–REVISED MARCH 2013												
REVISION HISTORY												
			REVISIO		RY							
NOTE: Page numbers for	previou	s revisions					ie cu	rrent versio	on.			
NOTE: Page numbers for Changes from Revision A (s may diffe	er from pag			ie cu	rrent versio	on.	Page		
Changes from Revision A (Septemi fication o	ber 2012) t of second li	s may diffe to Revision nput Bias C	er from pag B urrent, <i>I_B</i> pa	e numbers ir	n th n H	igh-V	oltage Elect		Page 3		
Changes from Revision A (Septemi fication of	ber 2012) t of second li	s may diffe to Revision nput Bias C	er from pag B urrent, / _B pa	e numbers ir rameter row ir	n th n H	igh-V	oltage Elect	rical	Page 		
Changes from Revision A (Changed maximum speci Characteristics table Changed maximum speci	Septemb fication of fication of e, Input i	ber 2012) t of second li of second li impedance	s may diffe to Revision nput Bias C nput Bias C (Common-	er from pag B urrent, / _B pa urrent, / _B pa	e numbers ir rameter row ir rameter row ir	n th n H	igh-V	oltage Elect	rical ical			
Changes from Revision A (Changed maximum speci Characteristics table Changed maximum speci Characteristics table Changed Input Impedanc Electrical Characteristics	Septeml fication of fication of e, Input i table	ber 2012) t of second li impedance e changi	s may diffe to Revision nput Bias C (Common-	er from pag B urrent, <i>I_B</i> pa urrent, <i>I_B</i> pa mode) parar	e numbers ir rameter row ir rameter row ir	n th n H	igh-V	oltage Elect	rical ical			
Changes from Revision A (• Changed maximum speci Characteristics table • Changed maximum speci Characteristics table • Changed Input Impedance Electrical Characteristics The datasheet number Device Family Cha	Septeml fication of fication of fication of e, <i>Input</i> i table	ber 2012) t of second lu of second lu impedance e changi om:	s may diffe to Revision nput Bias C nput Bias C (Common-	er from pag B urrent, I _B pa urrent, I _B pa mode) parar	e numbers ir rameter row ir rameter row ir	n th n H	igh-V	oltage Elect	rical ical			

Reason for Change:									
To more accurately reflect device characteristics.									
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):									
Electrical specification performance changes as indicated above.									
Changes to product identification resulting from this PCN:									
None									
Product Affected:									
OPA4188AID	OPA4188AIDR	OPA4188AIPW	OPA4188AIPWR						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com